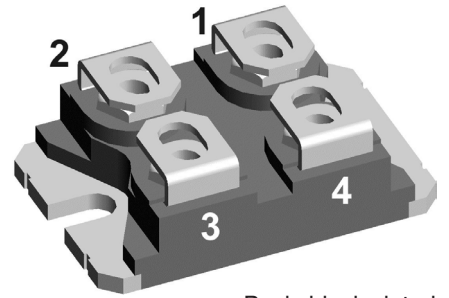


SiC Schottky Diode


 $V_{RRM} = 1200\text{ V}$
 $I_{FAV} = 2 \times 41\text{ A}$

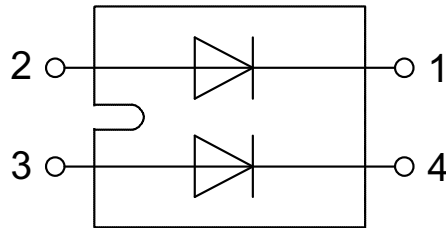
Ultra fast switching
 Zero reverse recovery

Part number
DCG85X1200NA



Backside: isolated

 E72873



Features / Advantages:

- Ultra fast switching
- Zero reverse recovery
- Zero forward recovery
- Temperature independent switching behavior
- Positive temperature coefficient of forward voltage
- $T_{VJM} = 175^{\circ}\text{C}$

Applications:

- Solar inverter
- Uninterruptible power supply (UPS)
- Welding equipment
- Switched-mode power supplies
- Medical equipment
- High speed rectifier

Package: SOT-227B (minibloc)

- Isolation Voltage: 2500 V~
- Industry standard outline
- RoHS compliant
- Epoxy meets UL 94V-0
- Base plate with Aluminium nitride isolation for low thermal resistance
- Advanced power cycling

Disclaimer Notice

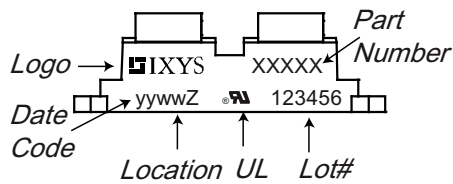
Information furnished is believed to be accurate and reliable. However, users should independently evaluate the suitability of and test each product selected for their own applications. Littelfuse products are not designed for, and may not be used in, all applications. Read complete Disclaimer Notice at www.littelfuse.com/disclaimer-electronics.

| SiC Diode (per leg) | | | | Ratings | | | |
|---------------------|--|--|------------------------|---------|------|------------|---|
| Symbol | Definitions | Conditions | min. | typ. | max. | | |
| V_{RSM} | max. non-repetitive reverse blocking voltage | | | | 1200 | V | |
| V_{RRM} | max. repetitive reverse blocking voltage | | | | 1200 | V | |
| I_R | reverse current | $V_R = V_{RRM}$ | | 70 | 400 | μA | |
| | | | | 130 | 800 | μA | |
| V_F | forward voltage | $I_F = 20 A$ | $T_{VJ} = 25^\circ C$ | 1.2 | | V | |
| | | | $T_{VJ} = 175^\circ C$ | 1.5 | 1.8 | V | |
| | | $I_F = 40 A$ | $T_{VJ} = 25^\circ C$ | | | | V |
| | | | $T_{VJ} = 175^\circ C$ | 1.3 | 3.0 | V | |
| I_{FAV} | average forward current | } rectangular, d = 0.5 $T_{VJ} = 175^\circ C$ | $T_C = 80^\circ C$ | | 41 | A | |
| | | | $T_C = 100^\circ C$ | | 36 | A | |
| I_{F25} | forward current | based on typ. V_{F0} and r_F | $T_C = 25^\circ C$ | | 73 | A | |
| I_{F80} | | | $T_C = 80^\circ C$ | | 56 | A | |
| I_{F100} | | | $T_C = 100^\circ C$ | | 49 | A | |
| I_{FSM} | max forward surge current | t = 10 ms, half sine (50 Hz) $t_p = 10 \mu s$, pulse; $V_R = 0V$ | $T_{VJ} = 25^\circ C$ | | 1150 | A | |
| V_{F0} | threshold voltage | } for power loss calculation | $T_{VJ} = 125^\circ C$ | 0.80 | | V | |
| r_F | slope resistance | | $T_{VJ} = 175^\circ C$ | 0.73 | | V | |
| | | | $T_{VJ} = 125^\circ C$ | 28.4 | | m Ω | |
| | | | $T_{VJ} = 175^\circ C$ | 35.2 | | m Ω | |
| Q_C | total capacitive charge | $V_R = 800 V$, $I_F = 40A$ $di/dt = 400 A/\mu s$ | $T_{VJ} = 25^\circ C$ | 200 | | nC | |
| C | total capacitance | } f = 1 MHz; $T_{VJ} = 25^\circ C$ | $V_R = 0 V$ | 3000 | | pF | |
| | | | $V_R = 400 V$ | 185 | | pF | |
| | | | $V_R = 800 V$ | 135 | | pF | |
| R_{thJC} | thermal resistance junction to case | with heatsink compound; IXYS test setup | | | 0.60 | K/W | |
| R_{thJH} | thermal resistance junction to heatsink | | | 0.72 | | K/W | |

| Package Outlines SOT-227B (minibloc) | | | Ratings | | | |
|--------------------------------------|-------------------------------|---|--|------|--------------|----------|
| Symbol | Definitions | Conditions | min. | typ. | max. | Unit |
| I_{RMS} | RMS current | per terminal | | | 100 | A |
| T_{stg} | storage temperature | | -40 | | 150 | °C |
| T_{op} | operation temperature | | -40 | | 150 | °C |
| T_{VJ} | virtual junction temperature | | -40 | | 175 | °C |
| Weight | | | | 30 | | g |
| M_D | mounting torque ¹⁾ | screws to heatsink terminal connection screws | | | 1.5 1.3 | Nm Nm |
| d_{Spp} | creepage distance on surface | terminal to terminal | 10.5 | | | mm |
| d_{Spb} | | terminal to backside | 8.5 | | | mm |
| d_{App} | striking distance through air | terminal to terminal | 3.2 | | | mm |
| d_{Apb} | | terminal to backside | 6.8 | | | mm |
| V_{ISOL} | isolation voltage | $I_{ISOL} \leq 1 \text{ mA}; 50/60 \text{ Hz}$ | $t = 1 \text{ sec.}$ $t = 1 \text{ minute}$ | | 3000 2500 | V V |
| C_p | coupling capacity per switch | between shorted terminals of one diode and back side metallization | | 20 | | pF |

¹⁾ further information see application note IXAN0073 on www.ixys.com/TechnicalSupport/appnotes.aspx (General / Isolation, Mounting, Soldering, Cooling)

Product Marking

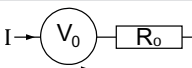


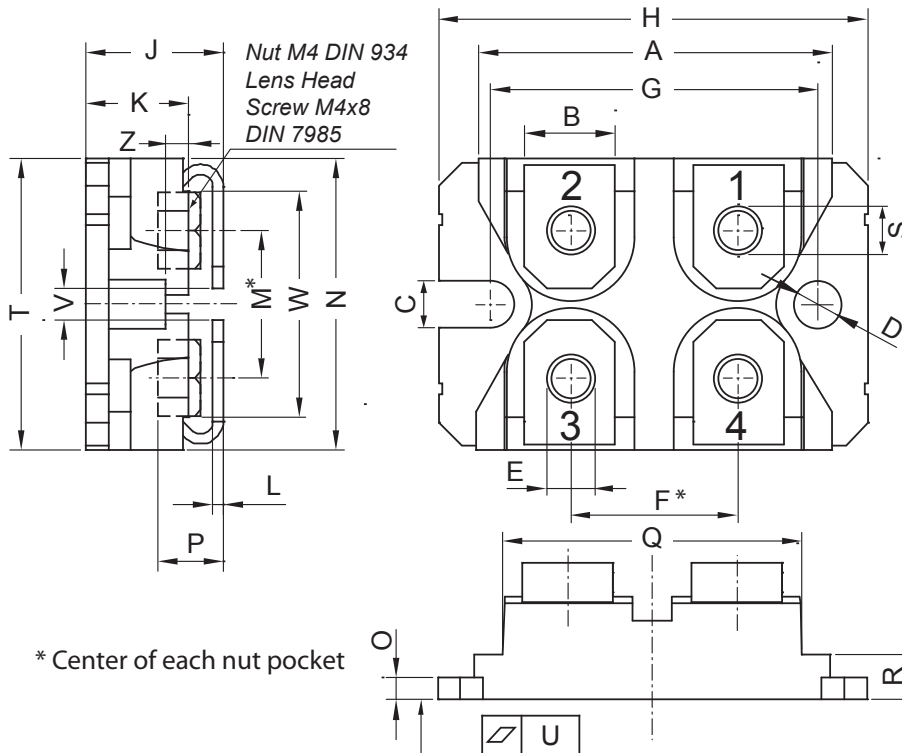
Part description

D = Diode
 C = SiC
 G = extreme fast
 85 = Current Rating [A]
 X = Parallel legs
 1200 = Reverse Voltage [V]
 NA = SOT-227 (minibloc)

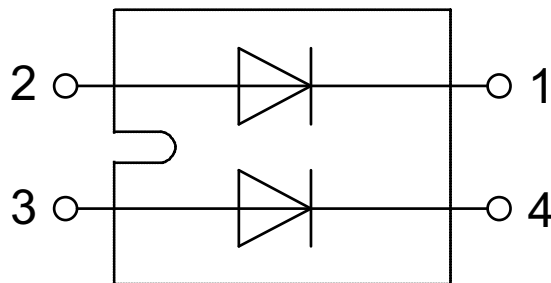
| Ordering | Part Name | Marking on Product | Delivering Mode | Base Qty | Ordering Code |
|----------|--------------|--------------------|-----------------|----------|---------------|
| Standard | DCG85X1200NA | DCG85X1200NA | Tube | 10 | DCG85X1200NA |

Equivalent Circuits for Simulation ^{*on die level, typical}

| | | $T_{VJ} = 125^\circ\text{C}$ | $T_{VJ} = 175^\circ\text{C}$ | |
|-----------------|---|------------------------------|------------------------------|----|
| $I \rightarrow$ |  | | | |
| $V_{0 \max}$ | threshold voltage | 0.80 | 0.73 | V |
| $R_{0 \max}$ | slope resistance * | 28.4 | 35.2 | mΩ |

Outlines SOT-227B (minibloc)


| Dim. | Millimeter | | Inches | |
|------|------------|-------|--------|-------|
| | min | max | min | max |
| A | 31.50 | 31.88 | 1.240 | 1.255 |
| B | 7.80 | 8.20 | 0.307 | 0.323 |
| C | 4.09 | 4.29 | 0.161 | 0.169 |
| D | 4.09 | 4.29 | 0.161 | 0.169 |
| E | 4.09 | 4.29 | 0.161 | 0.169 |
| F | 14.91 | 15.11 | 0.587 | 0.595 |
| G | 30.12 | 30.30 | 1.186 | 1.193 |
| H | 37.80 | 38.23 | 1.488 | 1.505 |
| J | 11.68 | 12.22 | 0.460 | 0.481 |
| K | 8.92 | 9.60 | 0.351 | 0.378 |
| L | 0.74 | 0.84 | 0.029 | 0.033 |
| M | 12.50 | 13.10 | 0.492 | 0.516 |
| N | 25.15 | 25.42 | 0.990 | 1.001 |
| O | 1.95 | 2.13 | 0.077 | 0.084 |
| P | 4.95 | 6.20 | 0.195 | 0.244 |
| Q | 26.54 | 26.90 | 1.045 | 1.059 |
| R | 3.94 | 4.42 | 0.155 | 0.167 |
| S | 4.55 | 4.85 | 0.179 | 0.191 |
| T | 24.59 | 25.25 | 0.968 | 0.994 |
| U | -0.05 | 0.10 | -0.002 | 0.004 |
| V | 3.20 | 5.50 | 0.126 | 0.217 |
| W | 19.81 | 21.08 | 0.780 | 0.830 |
| Z | 2.50 | 2.70 | 0.098 | 0.106 |



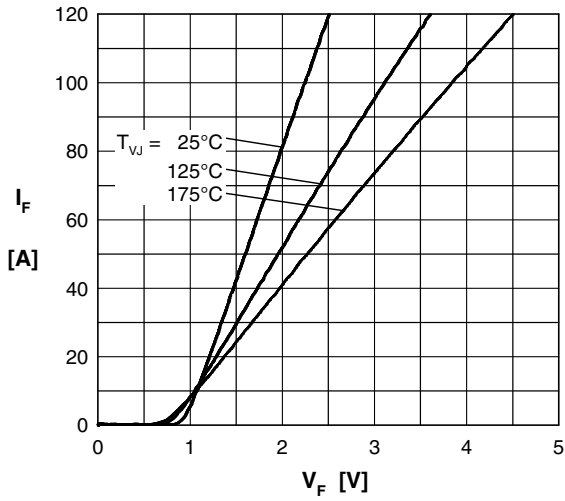
SiC Diode (per leg)


Fig. 1 Typ. forward characteristics

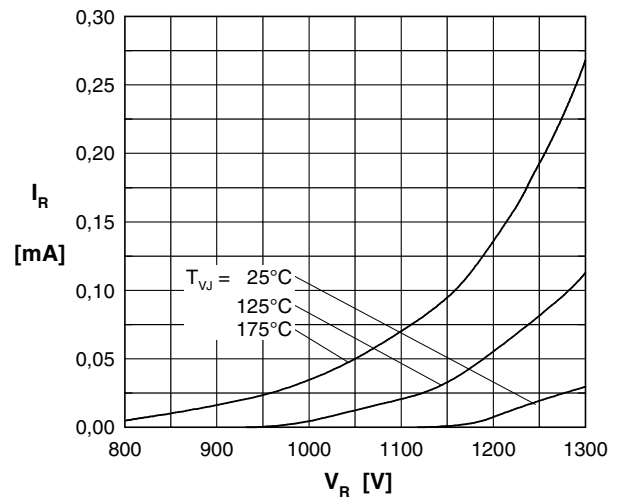


Fig. 2 Typ. reverse characteristics

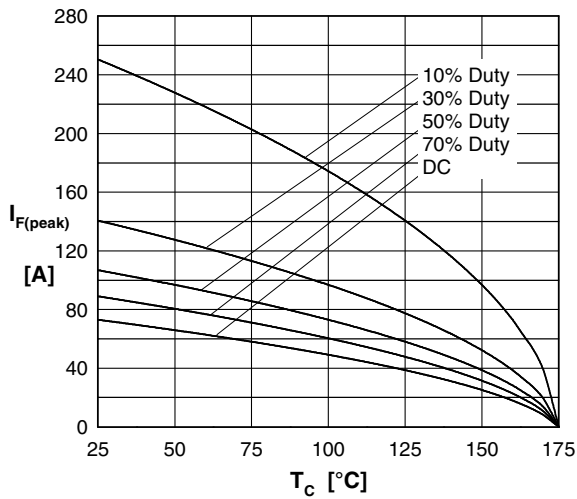


Fig. 3 Typ. current derating

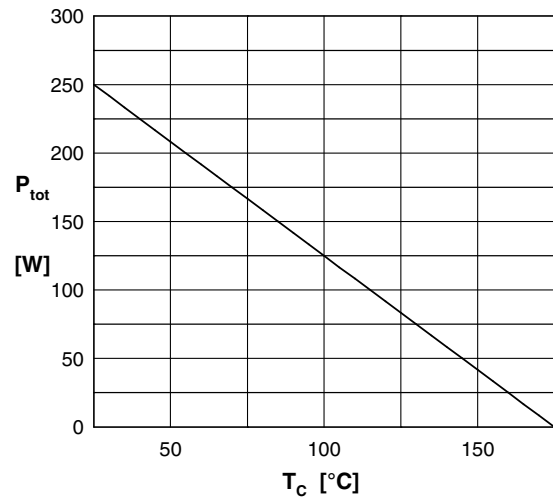


Fig. 4 Power derating

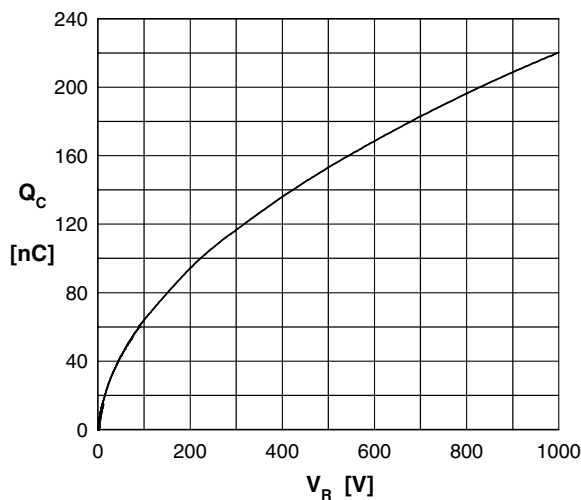


Fig. 5 Typ. recovery charge vs. reverse voltage

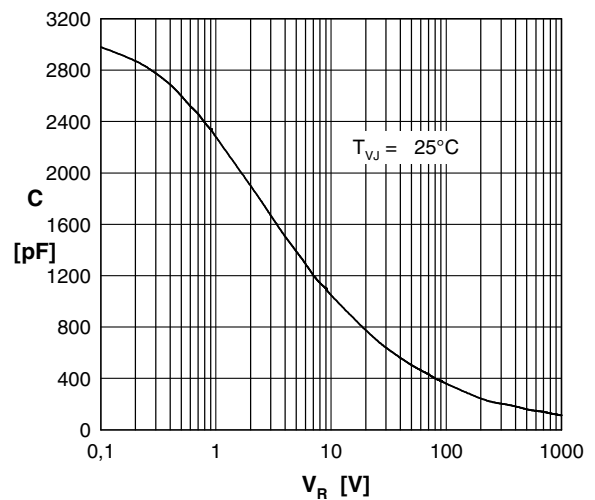


Fig. 6 Typ. junction capacitance vs. reverse Voltage

IXYS reserves the right to change limits, test conditions and dimensions.

20220608b

SiC Diode (per leg)

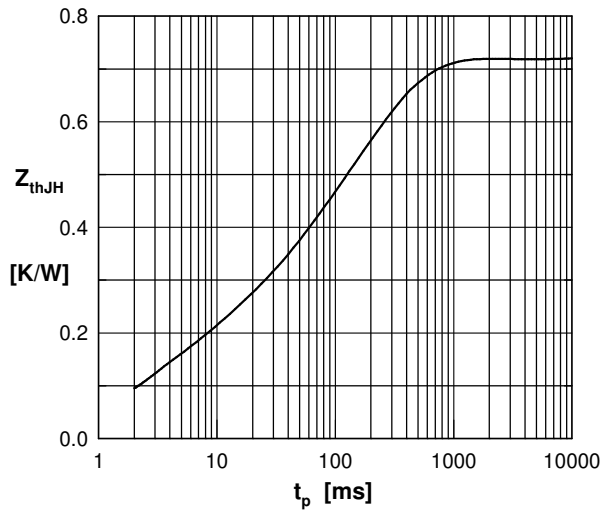


Fig. 7 Typ. transient thermal impedance